



# **SLD Series**





#### **Agency Approvals**

| AGENCY       | AGENCY FILE NUMBER |
|--------------|--------------------|
| . <b>9</b> U | E230531            |

#### **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

| Parameter   | Symbol                            | Value      | Unit |
|---|-----------------------------------|------------|------|
| Peak Pulse Power Dissipation 1. 100µs x 150ms test waveform                   | P <sub>PPM</sub>                  | 2200       | W    |
| 2. 8 x 20µs test waveform   | FFIVI                             | 50000      | W    |
| Steady State Power Dissipation on inifinite heat sink at $T_L$ =75°C (Fig. 5) | P <sub>M(AV)</sub>                | 8.0        | W    |
| Maximum Instantaneous Forward<br>Voltage at 100A for Unidirectional<br>only   | V <sub>F</sub>                    | 3.5        | V    |
| Operating Junction and Storage<br>Temperature Range                           | T <sub>J</sub> , T <sub>STG</sub> | -65 to 175 | °C   |
| Typical Thermal Resistance Junction to Lead                                   | R <sub>uJL</sub>                  | 8.0        | °C/W |
| Typical Thermal Resistance Junction to Ambient                                | R <sub>uJA</sub>                  | 40         | °C/W |

#### **Description**

The SLD Series is packaged in a highly reliable industry standard P600 axial leaded package and is designed to provide percision overvoltage protection for sensitive electronics.

#### **Features**

- Halogen-Free
- RoHS compliant
- Typical maximum temperature coefficient  $\Delta V_{BR} = 0.1\% \times V_{BR}@25^{\circ}C \times \Delta T$  • High temperature
- Glass passivated chip junction in P600 package
- ISO 7637-2 Level 4 Impulse 5a; 2200W peak pulse capability at 100µs × 150ms waveform, repetition rate (duty cycles): 0.01%
- Fast response time: typically less than 1.0ps from 0 Volts to BV min

- Excellent clamping capability
- Low incremental surge resistance
- soldering guaranteed: 260°C/40 seconds / 0.375",(9.5mm) lead length, 5 lbs., (2.3kg) tension
- Plastic package has Underwriters Laboratory Flammability classification 94V-O
- Matte Tin Lead–free plated

#### **Applications**

Designed to protect sensitive electronics from:

- Inductive Load Switching
- Alternator Load Dump

# Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

| Part<br>Number<br>(Uni) | Part<br>Number<br>(Bi) | Breakdown<br>Voltage V <sub>BR</sub> @ I <sub>T</sub><br>(V) |      |      | Reverse<br>Stand off<br>Voltage | Maximum<br>Reverse<br>Leakage @ V <sub>R</sub> | Maximum<br>Peak Pulse<br>Current | Maximum<br>Clamping<br>Voltage @ I <sub>PP</sub> | Agency<br>Approval |
|-------------------------|------------------------|--|------|------|---------------------------------|--|----------------------------------|--|--------------------|
| (3111)                  |                        | MIN  | MAX  | (mA) | V <sub>R</sub> (Volts)          | I <sub>R</sub> (μΑ)                            | I <sub>pp</sub> (A)              | V <sub>c</sub> (V)                               | 8/-                |
| SLD10U-017              | SLD10-018              | 11.8   | 13   | 5.0  | 10                              | 10   | 115                              | 19.0   | Х                  |
| SLD16U-017              | SLD16-018              | 18.0   | 22.0 | 1.0  | 16                              | 10   | 76                               | 28.6   | Х                  |
| SLD24U-017              | SLD24-018              | 25.0   | 30.0 | 1.0  | 24                              | 10   | 61                               | 36.0   | Х                  |

- 1.  $V_{BB}$  measured after  $I_{\tau}$  applied for 300 $\mu$ s,  $I_{\tau}$ = square wave pulse or equivalent.
- 2. Surge current waveform per 100µS x 150mS exponential wave and derated per Fig. 3.
- 3. All terms and symbols are consistent with ANSI/IEEE C62.35.



#### Ratings and Characteristic Curves (T<sub>a</sub>=25°C unless otherwise noted)

Figure 1 - Peak Pulse Power Rating Curve

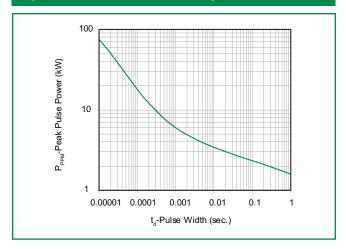


Figure 2 - Pulse Derating Curve

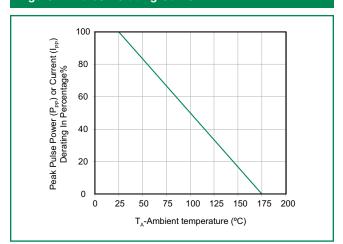


Figure 3 - Pulse Waveform

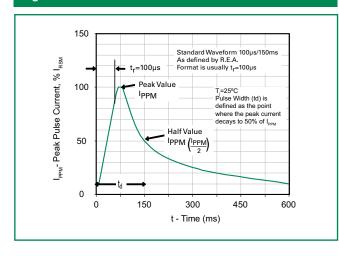


Figure 4 - Typical Junction Capacitance

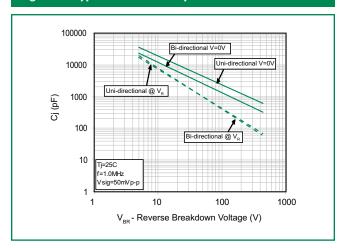


Figure 5 - Steady State Power Derating Curve

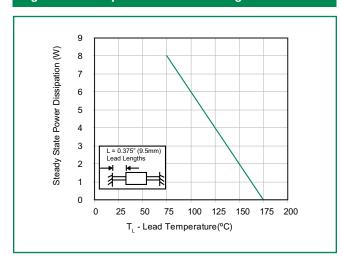
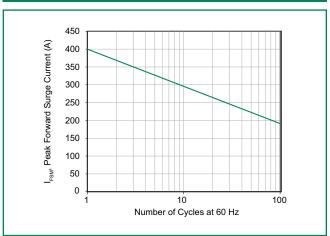


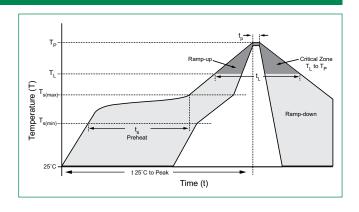
Figure 6 - Maximum Non-Repetitive Peak Forward Surge Current





# **Soldering Parameters**

| Reflow Co                | ondition                                       | Lead-free assembly      |
|--------------------------|--|-------------------------|
|                          | -Temperature Min (T <sub>s(min)</sub> )        | 150°C                   |
| Pre Heat                 | -Temperature Max (T <sub>s(max)</sub> )        | 200°C                   |
|                          | -Time (min to max) (t <sub>s</sub> )           | 60 – 180 secs           |
| Average r                | amp up rate (Liquidus Temp<br>ık               | 3°C/second max          |
| T <sub>S(max)</sub> to T | - Ramp-up Rate                                 | 3°C/second max          |
| Reflow                   | -Temperature (T <sub>L</sub> ) (Liquidus)      | 217°C                   |
| hellow                   | -Time (min to max) (t <sub>s</sub> )           | 60 – 150 seconds        |
| Peak Temp                | perature (T <sub>P</sub> )                     | 260 <sup>+0/-5</sup> °C |
| Time with                | in 5°C of actual peak<br>ure (t <sub>p</sub> ) | 20 – 40 seconds         |
| Ramp-dov                 | vn Rate  | 6°C/second max          |
| Time 25°C                | to peakTemperature (T <sub>P</sub> )           | 8 minutes Max.          |
| Do not ex                | ceed   | 280°C                   |



# Flow/Wave Soldering (Solder Dipping)

| Peak Temperature : | 265°C      |  |
|--------------------|------------|--|
| Dipping Time :     | 10 seconds |  |
| Soldering :        | 1 time     |  |

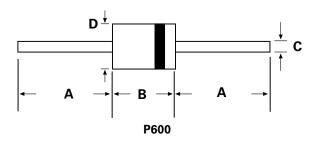
# **Physical Specifications**

| Weight   | 0.07oz., 2.1g                                       |  |  |
|----------|---|--|--|
| Case     | P600 molded plastic body over passivated junction.  |  |  |
| Polarity | Color band denotes the cathode except Bipolar.      |  |  |
| Terminal | Matte Tin axial leads, solderable per JESD22-B102D. |  |  |

#### **Environmental Specifications**

| Temperature Cycle  | JESD22-A104  |
|--------------------|--------------|
| Pressure Cooker    | JESD 22-A102 |
| High Temp. Storage | JESD22-A103  |
| HTRB               | JESD22-A108  |
| Thermal Shock      | JESD22-A106  |

#### **Dimensions**

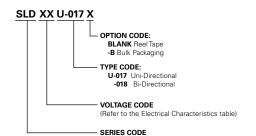


|  | Dimensions | Inc   | hes   | Millimeters |      |  |
|--|------------|-------|-------|-------------|------|--|
|  | Dimensions | Min   | Max   | Min         | Max  |  |
|  | Α          | 1.000 | -     | 25.40       | -    |  |
|  | В          | 0.340 | 0.360 | 8.60        | 9.10 |  |
|  | С          | 0.048 | 0.052 | 1.22        | 1.32 |  |
|  | D          | 0.340 | 0.360 | 8.60        | 9.10 |  |

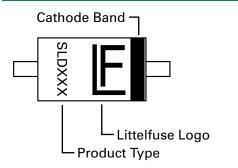
# **Transient Voltage Suppression Diodes**Axial Leaded – 2200W > SLD series



# **Part Numbering System**



# **Part Marking System**



# **Packaging**

| Part Number | Component<br>Package | Quantity | Packaging<br>Option | Packaging Specification                  |
|-------------|----------------------|----------|---------------------|--|
| SLDxxXXX    | P600                 | 800      | Tape & Reel         | EIA STD RS-296E                          |
| SLDxxXX-B   | P600                 | 500      | вох                 | Littelfuse Concord Packing Spec. DM-0016 |